6AM14

Silicon N-Channel/P-Channel Power MOS FET Array

HITACHI

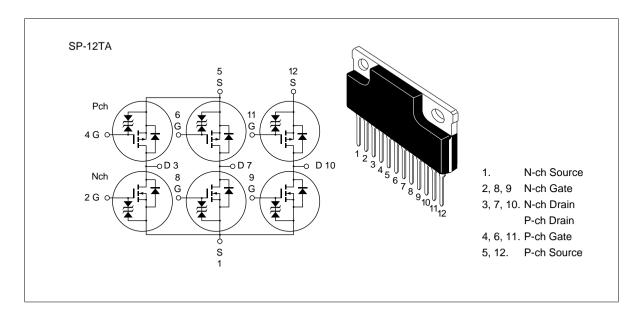
Application

High speed power switching

Features

- Low on-resistance
- Low drive current
- High speed switching
- High density mounting

Outline





6AM14

Absolute Maximum Ratings (Ta = 25°C)

| | | | gs | |
|-------------------------|--------------------------|--------|------------|------|
| Item | Symbol | Nch | Pch | Unit |
| Drain to source voltage | V _{DSS} | 60 | -60 | V |
| Gate to source voltage | V _{GSS} | ±20 | ±20 | V |
| Drain current | I _D | 7 | - 7 | A |
| Drain peak current | I _{D(pulse)} *1 | 28 | -28 | A |
| Reverse drain current | I _{DR} | 7 | - 7 | A |
| Channel dissipation | Pch*2 | 42 | | W |
| Channel dissipation | Pch*2 | 4.8 | | W |
| Channel temperature | Tch | 150 | | °C |
| Storage temperature | Tstg | -55 to | +150 | °C |

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at 6 Drive operation

Electrical Characteristics N Channel (Ta = 25°C)

| Item | Symbol | Min | Тур | Max | Unit | Test conditions |
|--|---------------------|-----|------|-----|------|---|
| Drain to source breakdown voltage | $V_{(BR)DSS}$ | 60 | _ | _ | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| Gate to source breakdown voltage | $V_{(BR)GSS}$ | ±20 | _ | _ | V | $I_G = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | I _{GSS} | _ | _ | ±10 | μΑ | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | I _{DSS} | _ | _ | 250 | μΑ | $V_{DS} = 50 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | $V_{GS(off)}$ | 0.5 | _ | 1.5 | V | $V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$ |
| Static drain to source on state resistance | $R_{DS(on)}$ | _ | 0.14 | 0.2 | Ω | $I_D = 4 A$ $V_{GS} = 4 V^{*1}$ |
| | | _ | 0.22 | 0.5 | Ω | $I_D = 2 A$ $V_{GS} = 2.5 V^{*1}$ |
| Forward transfer admittance | $ y_{fs} $ | 4.0 | 6.5 | _ | S | $I_D = 4 A$ $V_{DS} = 10 V^{*1}$ |
| Input capacitance | Ciss | _ | 500 | _ | pF | $V_{DS} = 10 \text{ V}$ |
| Output capacitance | Coss | _ | 240 | _ | pF | $V_{GS} = 0$ |
| Reverse transfer capacitance | Crss | _ | 30 | _ | pF | f = 1 MHz |
| Turn-on delay time | $t_{\text{d(on)}}$ | _ | 15 | _ | ns | $V_{GS} = 10 \text{ V}, I_{D} = 4 \text{ A}$ |
| Rise time | t _r | _ | 90 | _ | ns | $R_L = 7.5 \Omega$ |
| Turn-off delay time | $t_{\text{d(off)}}$ | _ | 110 | _ | ns | |
| Fall time | t _f | _ | 250 | _ | ns | |
| Body to drain diode forward voltage | V_{DF} | _ | 1.0 | _ | V | $I_F = 7 \text{ A}, V_{GS} = 0$ |
| Body to drain diode reverse recovery time | t _{rr} | _ | 170 | _ | ns | $I_F = 7 \text{ A}, V_{GS} = 0$ diF/dt = 50 A/ μ s |

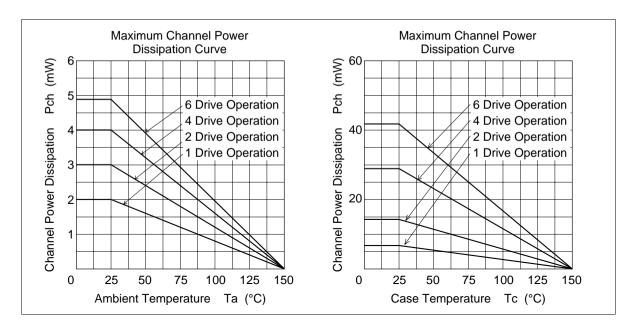
Note: 1. Pulse Test

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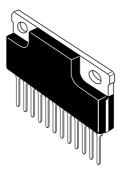
Electrical Characteristics P Channel (Ta = 25°C)

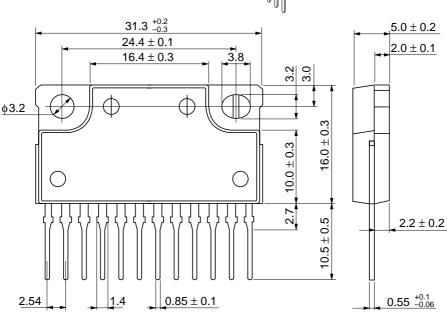
| Item | Symbol | Min | Тур | Max | Unit | Test conditions |
|--|---------------------|------|------|------|------|--|
| Drain to source breakdown voltage | $V_{(BR)DSS}$ | -60 | _ | _ | V | $I_D = -10 \text{ mA}, V_{GS} = 0$ |
| Gate to source breakdown voltage | $V_{(BR)GSS}$ | ±20 | _ | _ | V | $I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | I _{GSS} | _ | _ | ±10 | μΑ | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | I _{DSS} | _ | _ | -250 | μΑ | $V_{DS} = -50 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | $V_{GS(off)}$ | -0.5 | _ | -1.5 | V | $V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$ |
| Static drain to source on state resistance | $R_{DS(on)}$ | _ | 0.12 | 0.16 | Ω | $I_D = -4 A$ $V_{GS} = -4 V^{*1}$ |
| | | _ | 0.16 | 0.3 | Ω | $I_D = -2 A$ $V_{GS} = -2.5 V^{*1}$ |
| Forward transfer admittance | $ y_{fs} $ | 5.0 | 8.0 | _ | S | $I_D = -4 A$ $V_{DS} = -10 V^{*1}$ |
| Input capacitance | Ciss | _ | 1450 | _ | pF | $V_{DS} = -10 \text{ V}$ |
| Output capacitance | Coss | _ | 590 | _ | pF | $V_{GS} = 0$ |
| Reverse transfer capacitance | Crss | _ | 120 | _ | pF | f = 1 MHz |
| Turn-on delay time | $t_{\text{d(on)}}$ | _ | 15 | _ | ns | $V_{GS} = -10 \text{ V}, I_{D} = -4 \text{ A}$ |
| Rise time | t _r | _ | 75 | _ | ns | $R_L = 7.5 \Omega$ |
| Turn-off delay time | $t_{\text{d(off)}}$ | _ | 240 | _ | ns | _ |
| Fall time | t _f | _ | 180 | _ | ns | _ |
| Body to drain diode forward voltage | V_{DF} | _ | -1.0 | _ | V | $I_F = -7 \text{ A}, V_{GS} = 0$ |
| Body to drain diode reverse recovery time | t _{rr} | _ | 210 | _ | ns | $I_F = -7 \text{ A}, V_{GS} = 0$ diF/dt = 50 A/ μ s |

Note: 1. Pulse Test



Unit: mm





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| Hitachi Code | SP-12TA |
|--------------------------|---------|
| JEDEC | |
| EIAJ | |
| Weight (reference value) | 6.1 g |

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HITACHI

Hitachi, Ltd.

Semiconductor & Integrated Circuits.

Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223 Hitachi Europe GmbH Electronic components Group Dornacher Stra§e 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0

Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.

Electronic Components Group.

Whitebrook Park Lower Cookham Road Maidenhead

Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000

Tel: <44> (1628) 585000 Fax: <44> (1628) 778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 049318 Tel: 535-2100 Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building. No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666

Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218

Fax: <852> (2) 735 9218 Fax: <852> (2) 730 0281 Telex: 40815 HITEC HX

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